Octal D-type transparent latch; 3-state Rev. 6 — 26 January 2015

#### **General description** 1.

The 74HC573; 74HCT573 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard no. 7A.

The 74HC573; 74HCT573 has octal D-type transparent latches featuring separate D-type inputs for each latch and 3-state true outputs for bus-oriented applications. A latch enable (LE) input and an output enable (OE) input are common to all latches.

When LE is HIGH, data at the Dn inputs enter the latches. In this condition, the latches are transparent, i.e. a latch output changes state each time its corresponding D input changes.

When LE is LOW the latches store the information that was present at the D-inputs a set-up time preceding the HIGH-to-LOW transition of LE. When OE is LOW, the contents of the 8 latches are available at the outputs. When OE is HIGH, the outputs go to the high-impedance OFF-state. Operation of the OE input does not affect the state of the latches.

The 74HC573; 74HCT573 is functionally identical to:

- 74HC563; 74HCT563, but inverted outputs
- 74HC373; 74HCT373, but different pin arrangement

#### 2. Features and benefits

- Input levels:
  - For 74HC573: CMOS level
  - For 74HCT573: TTL level
- Inputs and outputs on opposite sides of package allowing easy interface with microprocessors
- Useful as input or output port for microprocessors and microcomputers
- 3-state non-inverting outputs for bus-oriented applications
- Common 3-state output enable input
- Multiple package options
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C



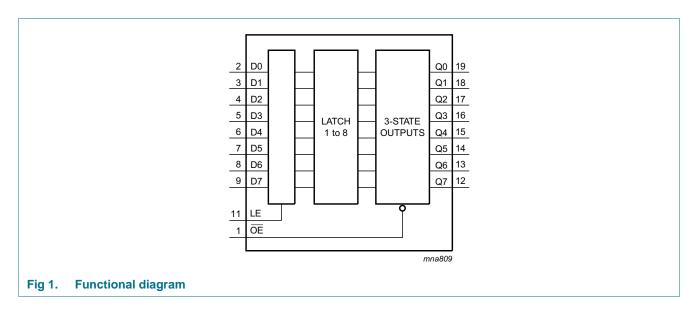
Octal D-type transparent latch; 3-state

### 3. Ordering information

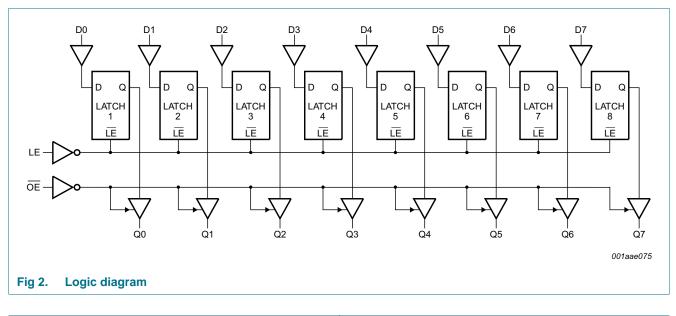
#### Table 1. Ordering information

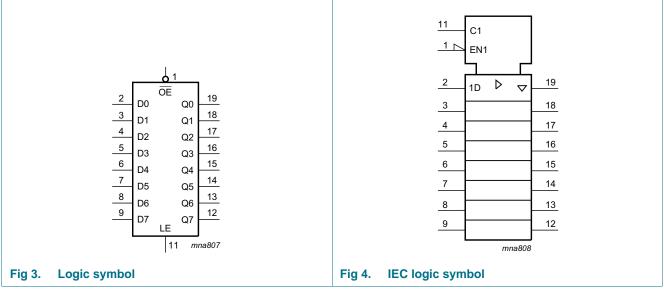
Type number	Package			
	Temperature range	Name	Description	Version
74HC573N	–40 °C to +125 °C	DIP20	plastic dual in-line package; 20 leads (300 mil)	SOT146-1
74HCT534N	-			
74HC573D	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1
74HCT573D			body width 7.5 mm	
74HC573DB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads;	SOT339-1
74HCT573DB	-		body width 5.3 mm	
74HC573PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1
74HCT573PW			body width 4.4 mm	
74HC573BQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very	SOT764-1
74HCT573BQ			thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	

### 4. Functional diagram



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### 5. Pinning information

#### 5.1 Pinning 74HC573 74HCT573 V<sub>CC</sub> terminal 1 Ы index area 20 -] 74HC573 2) (19 Q0 D0 74HCT573 D1 3) (18 Q1 ŌĒ 1 20 V<sub>CC</sub> (17 D2 4) Q2 D0 2 19 Q0 (16 Q3 D3 5) 18 Q1 D1 3 (15 D2 4 17 Q2 D4 6) Q4 D3 5 16 Q3 D5 7) (14 Q5 GND<sup>(1)</sup> 15 Q4 D4 6 D6 8) (13 Q6 D5 7 14 Q5 D7 9) (12 Q7 D6 8 13 Q6 ₽ E 12 Q7 D7 9 Щ GND 001aae077 GND 10 11 LE Transparent top view 001aae076 (1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND. Fig 5. Pin configuration DIP20, SO20, SSOP20 and Fig 6. **Pin configuration DHVQFN20** TSSOP20

### 5.2 Pin description

Table 2. P	Table 2.     Pin description							
Symbol	Pin	Description						
OE	1	3-state output enable input (active LOW)						
D[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input						
GND	10	ground (0 V)						
LE	11	latch enable input (active HIGH)						
Q[0:7]	19, 18, 17, 16, 15, 14, 13, 12	3-state latch output						
V <sub>CC</sub>	20	supply voltage						

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### 6. Functional description

#### Table 3.Function table

Operating mode	Control		Input	Internal	Output
	OE	LE	Dn	latches	Qn
Enable and read register (transparent	L	Н	L	L	L
mode)			Н	Н	Н
Latch and read register	L	L	I	L	L
			h	Н	Н
Latch register and disable outputs	Н	L	I	L	Z
			h	Н	Z

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;

Z = high-impedance OFF-state.

### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V		-	±20	mA
Ι <sub>ΟΚ</sub>	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V		-	±20	mA
lo	output current	$V_{O} = -0.5 \text{ V to} (V_{CC} + 0.5 \text{ V})$		-	±35	mA
I <sub>CC</sub>	supply current			-	+70	mA
I <sub>GND</sub>	ground current			-	-70	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	DIP20 package	[1]	-	750	mW
		SO20, SSOP20, TSSOP20 and DHVQFN20 packages	[2]	-	500	mW

[1] For DIP20 package:  $P_{tot}$  derates linearly with 12 mW/K above 70  $^\circ C.$ 

[2] For SO20:  $P_{tot}$  derates linearly with 8 mW/K above 70  $^\circ C.$ 

For SSOP20 and TSSOP20 packages:  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C. For DHVQFN20 package:  $P_{tot}$  derates linearly with 4.5 mW/K above 60 °C.

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### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		74HC573	3	74HCT573			Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

### 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Мах	1
74HC57	3					1	1	1	1	
VIH	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>		V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub> HIGH-level		$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O}$ = 7.8 mA; $V_{CC}$ = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>OZ</sub>	OFF-state output current		-	-	±0.5	-	±5.0	-	±10.0	μA

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Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
lcc	supply current		-	-	8.0	-	80	-	160	μA
CI	input capacitance		-	3.5	-					pF
74HCT5	73									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>он</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -6 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 6.0 mA	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
l <sub>oz</sub>	OFF-state output current	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5$ V; $V_{O} = V_{CC}$ or GND per input pin; other inputs at $V_{CC}$ or GND; $I_{O} = 0$ A	-	-	±0.5	-	±5.0	-	±10	μA
lcc	supply current		-	-	8.0	-	80	-	160	μΑ
∆I <sub>CC</sub>	additional supply current	$\label{eq:VI} \begin{array}{l} V_I = V_{CC} - 2.1 \text{ V};\\ \text{other inputs at } V_{CC} \text{ or GND};\\ V_{CC} = 4.5 \text{ V to 5.5 V};\\ I_O = 0 \text{ A} \end{array}$								
		per input pin; Dn inputs	-	35	126	-	158	-	172	μA
		per input pin; LE input	-	65	234	-	293	-	319	μA
		per input pin; OE input	-	125	450	-	563	-	613	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

#### Table 6. Static characteristics ... continued

Octal D-type transparent latch; 3-state

### **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 11.

Symbol	Parameter	Conditions		25 °C		<b>−40 °C</b>	to +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC573	3					1	1	1		
t <sub>pd</sub>	propagation	Dn to Qn; see Figure 7	1]							
	delay	V <sub>CC</sub> = 2.0 V	-	47	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	17	30	-	38	-	45	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	14	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	-	33	-	38	ns
t <sub>pd</sub>	propagation	LE to Qn; see Figure 8	1]							
	delay	V <sub>CC</sub> = 2.0 V	-	50	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	18	30	-	38	-	45	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	15	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$	-	14	26	-	33	-	38	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 9	2]							
		V <sub>CC</sub> = 2.0 V	-	44	140	-	175	-	210	ns
		V <sub>CC</sub> = 4.5 V	-	16	28	-	35	-	42	ns
		$V_{CC} = 6.0 V$	-	13	24	-	30	-	36	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 9	3]							
		V <sub>CC</sub> = 2.0 V	-	55	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	20	30	-	38	-	45	ns
		V <sub>CC</sub> = 6.0 V	-	16	26	-	33	-	38	ns
t <sub>t</sub>	transition	Qn; see Figure 7	4]							
	time	V <sub>CC</sub> = 2.0 V	-	14	60	-	75	-	90	ns
		V <sub>CC</sub> = 4.5 V	-	5	12	-	15	-	18	ns
		$V_{CC} = 6.0 V$	-	4	10	-	13	-	15	ns
tw	pulse width	LE HIGH; see Figure 8								
		V <sub>CC</sub> = 2.0 V	80	14	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	5	-	20	-	24	-	ns
		$V_{CC} = 6.0 V$	14	4	-	17	-	20	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 10								
		V <sub>CC</sub> = 2.0 V	50	11	-	65	-	75	-	ns
		V <sub>CC</sub> = 4.5 V	10	4	-	13	-	15	-	ns
		V <sub>CC</sub> = 6.0 V	9	3	-	11	-	13	-	ns
t <sub>h</sub>	hold time	Dn to LE; see Figure 10								
		$V_{CC} = 2.0 V$	5	3	-	5	-	5	-	ns
		$V_{\rm CC} = 4.5  \rm V$	5	1	-	5	-	5	-	ns
		$V_{CC} = 6.0 V$	5	1	-	5	-	5	-	ns
C <sub>PD</sub>	power dissipation capacitance		5] -	26	-	-	-	-	-	pF

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Symbol	Parameter	Conditions			25 °C		–40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	-
74HCT5	73										
t <sub>pd</sub>	propagation	Dn to Qn; see Figure 7	[1]								
	delay	V <sub>CC</sub> = 4.5 V		-	20	35	-	44	-	53	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	17	-	-	-	-	-	ns
t <sub>pd</sub>	propagation	LE to Qn; see Figure 8	[1]								
	delay	V <sub>CC</sub> = 4.5 V		-	18	35	-	44	-	53	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	15	-	-	-	-	-	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 9	[2]								
		V <sub>CC</sub> = 4.5 V		-	17	30	-	38	-	45	ns
t <sub>dis</sub> disable time	OE to Qn; see Figure 9	[3]									
		V <sub>CC</sub> = 4.5 V		-	18	30	-	38	-	45	ns
t <sub>t</sub>	transition	Qn; see Figure 7	[4]								
	time	V <sub>CC</sub> = 4.5 V		-	5	12	-	15	-	18	ns
t <sub>W</sub>	pulse width	LE HIGH; see Figure 8									
		V <sub>CC</sub> = 4.5 V		16	5	-	20	-	24	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 10									
		V <sub>CC</sub> = 4.5 V		13	7	-	16	-	20	-	ns
t <sub>h</sub>	hold time	Dn to LE; see Figure 10									
		V <sub>CC</sub> = 4.5 V		9	4	-	11	-	15	-	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; f = 1 MHz; V <sub>I</sub> = GND to V <sub>CC</sub> - 1.5 V	<u>[5]</u>	-	26	-	-	-	-	-	pF

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 11.

 $\label{eq:tpd} [1] \quad t_{pd} \mbox{ is the same as } t_{PLH} \mbox{ and } t_{PHL}.$ 

- $\label{eq:tensor} \begin{tabular}{c} [2] & t_{en} \mbox{ is the same as } t_{PZH} \mbox{ and } t_{PZL}. \end{tabular}$
- $[3] \quad t_{dis} \mbox{ is the same as } t_{PLZ} \mbox{ and } t_{PHZ}.$
- $[4] \quad t_t \text{ is the same as } t_{THL} \text{ and } t_{TLH}.$
- [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:
  - $f_i$  = input frequency in MHz;
  - $f_o = output$  frequency in MHz;

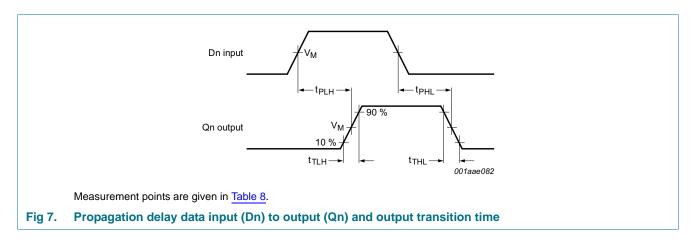
 $C_L$  = output load capacitance in pF;

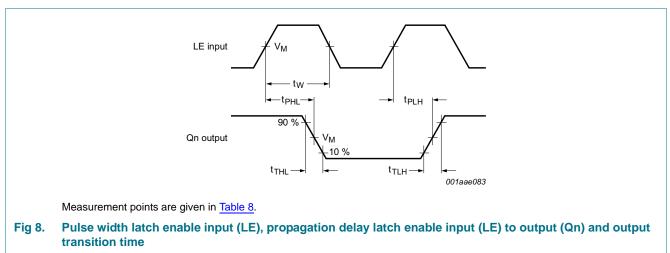
- $V_{CC}$  = supply voltage in V;
- N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of outputs.

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### 11. Waveforms

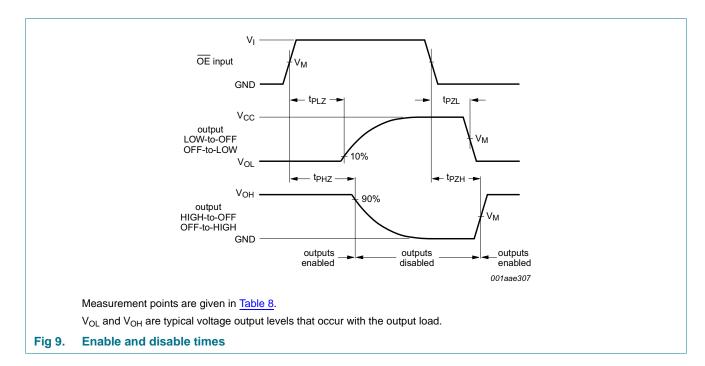


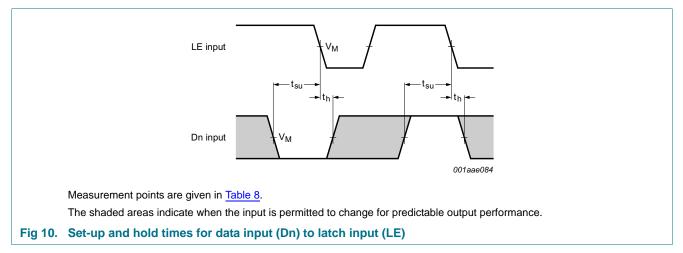


#### **NXP Semiconductors**

# 74HC573; 74HCT573

Octal D-type transparent latch; 3-state





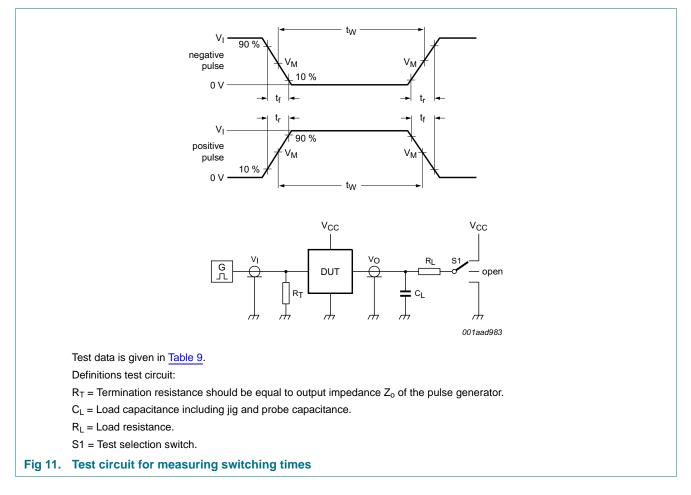
#### Table 8.Measurement points

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC573	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT573	1.3 V	1.3 V

### **NXP Semiconductors**

# 74HC573; 74HCT573

#### Octal D-type transparent latch; 3-state



#### Table 9. Test data

Туре	Input		Load		S1 position			
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	
74HC573	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>	
74HCT573	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>	

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### 12. Package outline

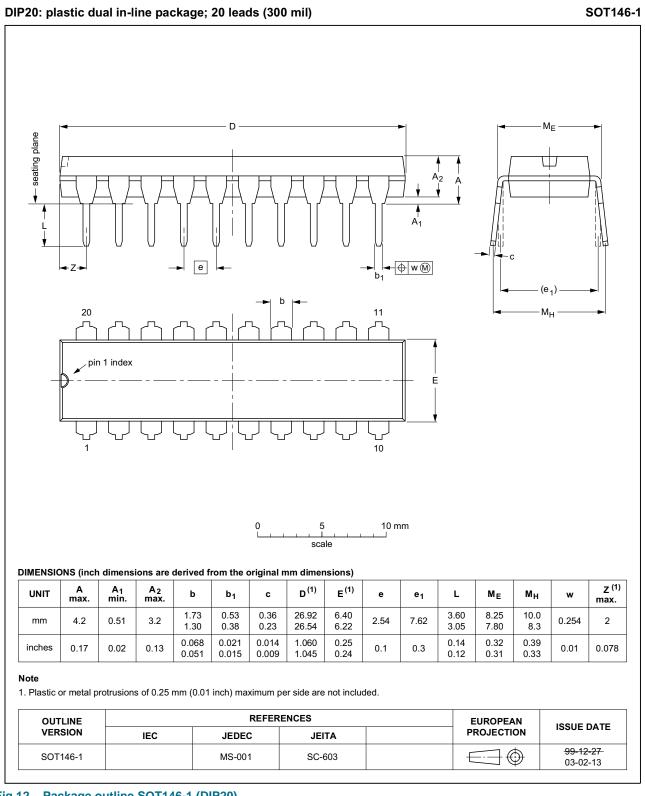


Fig 12. Package outline SOT146-1 (DIP20)

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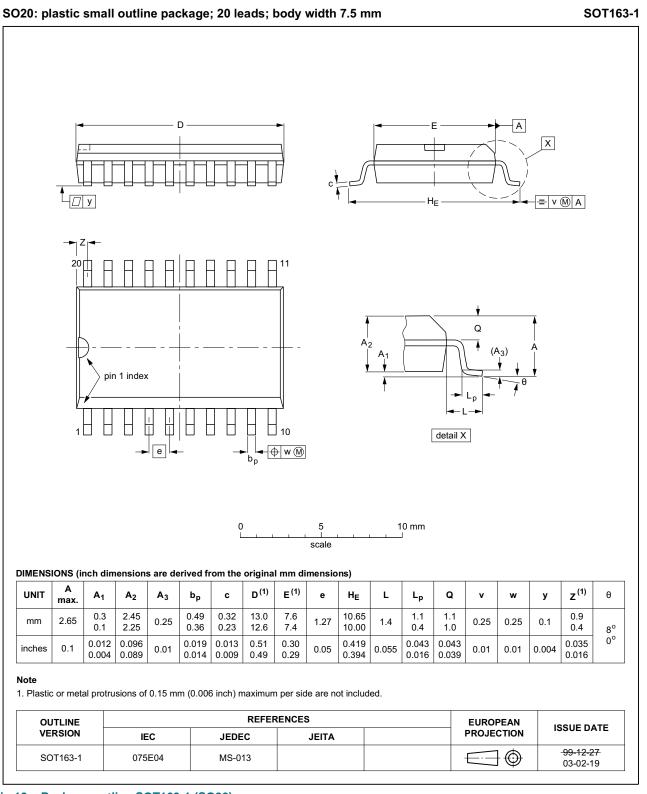


Fig 13. Package outline SOT163-1 (SO20)

Octal D-type transparent latch; 3-state

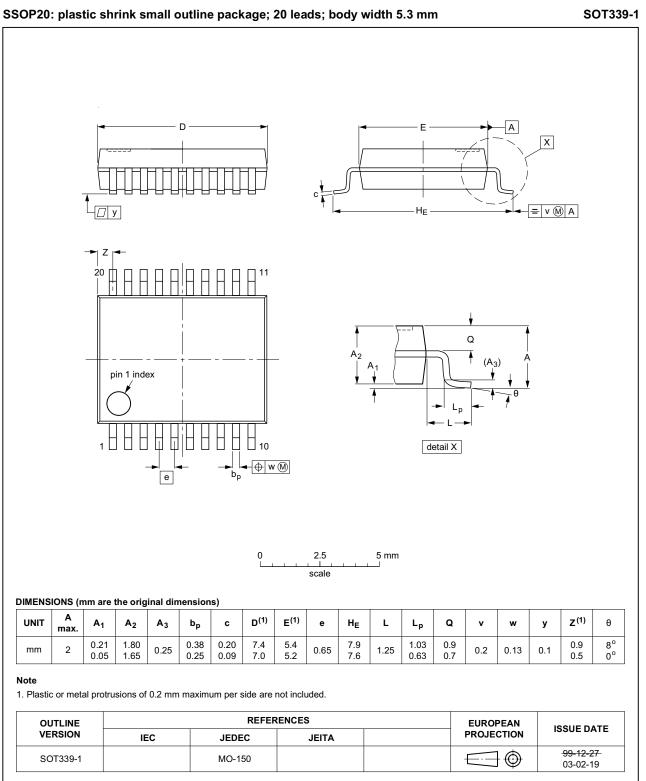
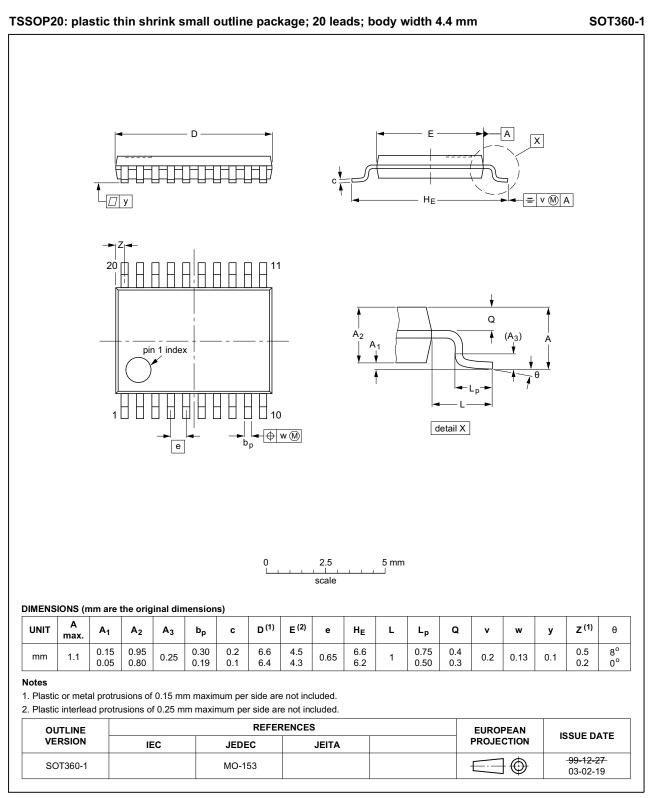


Fig 14. Package outline SOT339-1 (SSOP20)

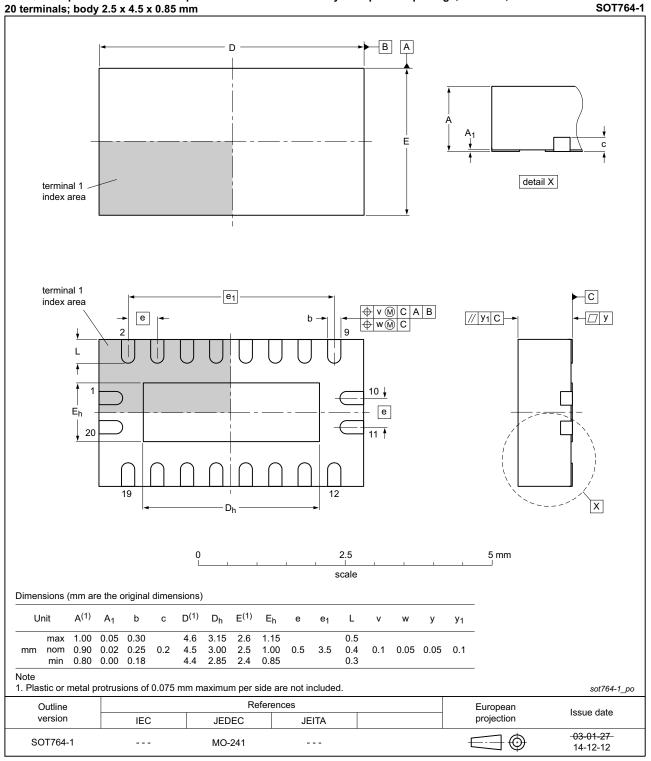
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#### Fig 15. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals: body 2.5 x 4.5 x 0.85 mm

#### Fig 16. Package outline SOT764-1 (DHVQFN20)

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## **13. Abbreviations**

Table 10. Abbreviations						
Acronym	Description					
CMOS	Complementary Metal Oxide Semiconductor					
DUT	Device Under Test					
ESD	ElectroStatic Discharge					
НВМ	Human Body Model					
MM	Machine Model					
TTL	Transistor-Transistor Logic					

## 14. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT573 v.6	20150126	Product data sheet	-	74HC_HCT573 v.5	
Modifications:	• <u>Table 7</u> : Power dissipation capacitance condition for 74HCT573 is corrected.				
74HC_HCT573 v.5	20120815	Product data sheet	-	74HC_HCT573 v.4	
Modifications:	Alternative descriptive title corrected (errata).				
74HC_HCT573 v.4	20120806	Product data sheet	-	74HC_HCT573 v.3	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>				
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
74HC_HCT573 v.3	20060117	Product data sheet	-	74HC_HCT573_CNV v.2	
74HC_HCT573_CNV v.2	19901201	Product specification	-	-	

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### **15. Legal information**

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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